



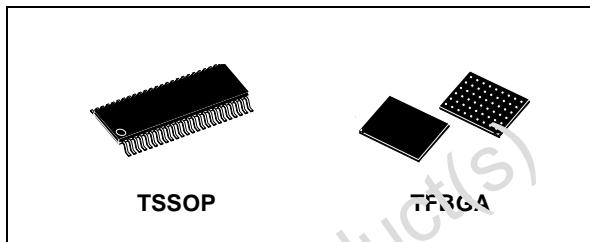
# 74LVTH16244

## LOW VOLTAGE BICMOS 16 BIT BUS BUFFER WITH BUS HOLD AND POWER UP 3-STATE

- HIGH SPEED:  
 $t_{PD} = 3.2\text{ns}$  (MAX.) at  $T_A = 85^\circ\text{C}$   $V_{CC} = 3.0\text{V}$
- LOW POWER DISSIPATION HIGH LEVEL  
OUTPUT:  $I_{CC} = 190\mu\text{A}$  (MAX.) at  $T_A = 85^\circ\text{C}$
- OUTPUT IMPEDANCE:  
 $|I_{OH}| = 32\text{mA}$ ,  $I_{OL} = 64\text{mA}$  (MIN at  $V_{CC} = 3.0\text{V}$ )  
 $|I_{OH}| = 8\text{mA}$ ,  $I_{OL} = 24\text{mA}$  (MIN at  $V_{CC} = 2.7\text{V}$ )
- BALANCED PROPAGATION DELAYS:  
 $t_{PLH} \equiv t_{PHL}$
- POWER DOWN PROTECTION ON INPUTS  
AND OUTPUTS
- COMPATIBLE WITH TTL OUTPUTS:  
 $V_{IH} = 2\text{V}$  (MIN),  $V_{IL} = 0.8\text{V}$  (MAX) at  
 $V_{CC} = 2.7$  to  $3.6\text{V}$
- POWER-UP/DOWN 3-STATE:  $I_{OZPU} = 100\mu\text{A}$   
MAX at  $V_{CC} = 0\text{V}$  to  $1.5\text{V}$ ,  $V_{CC} = 1.5\text{V}$  to  $0\text{V}$ ,  $T_A = 85^\circ\text{C}$
- BUS HOLD PROVIDED ON DATA INPUTS
- OPERATING VOLTAGE RANGE:  
 $V_{CC}(\text{OPR}) = 2.7\text{V}$  to  $3.6\text{V}$
- PIN AND FUNCTION COMPATIBLE WITH  
74 SERIES H16244
- LATCH-UP PERFORMANCE EXCEEDS  
500mA (JESD 17)

### DESCRIPTION

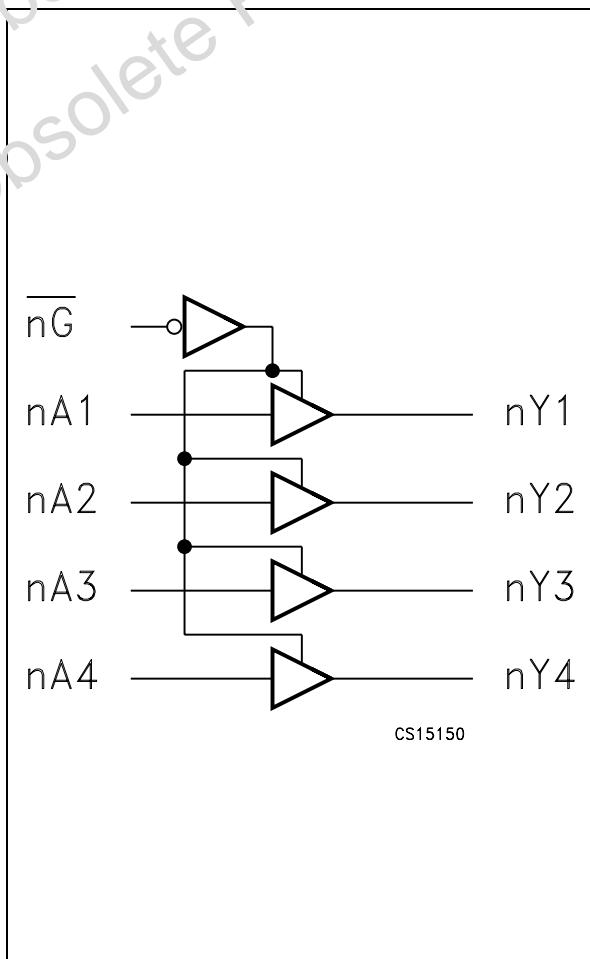
The 74LVTH16244 is a low voltage BiCMOS 16 BIT BUS BUFFER (NON-INVERTED) fabricated with sub-micron silicon gate and five-layer metal wiring BiCMOS technology. It is ideal and full specified for hot-insertion and high speed 3.3V applications; the power-up/down 3-state circuitry places the outputs in the high impedance state during power-up/down, which prevents driver conflict. This function is guaranteed when  $V_{CC}$  is between 0 and 1.5V. It can be interfaced to 3.3V signal environment for both inputs and outputs. Any  $nG$  output control governs four BUS BUFFERS. Output Enable input ( $nG$ ) tied together gives full 16-bit operation. When  $nG$  is LOW, the outputs are on. When  $nG$  is HIGH, the output are in high impedance state effectively isolated. Bus hold on data inputs is provided in order to eliminate the need for external pull-up or pull-down resistors. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.



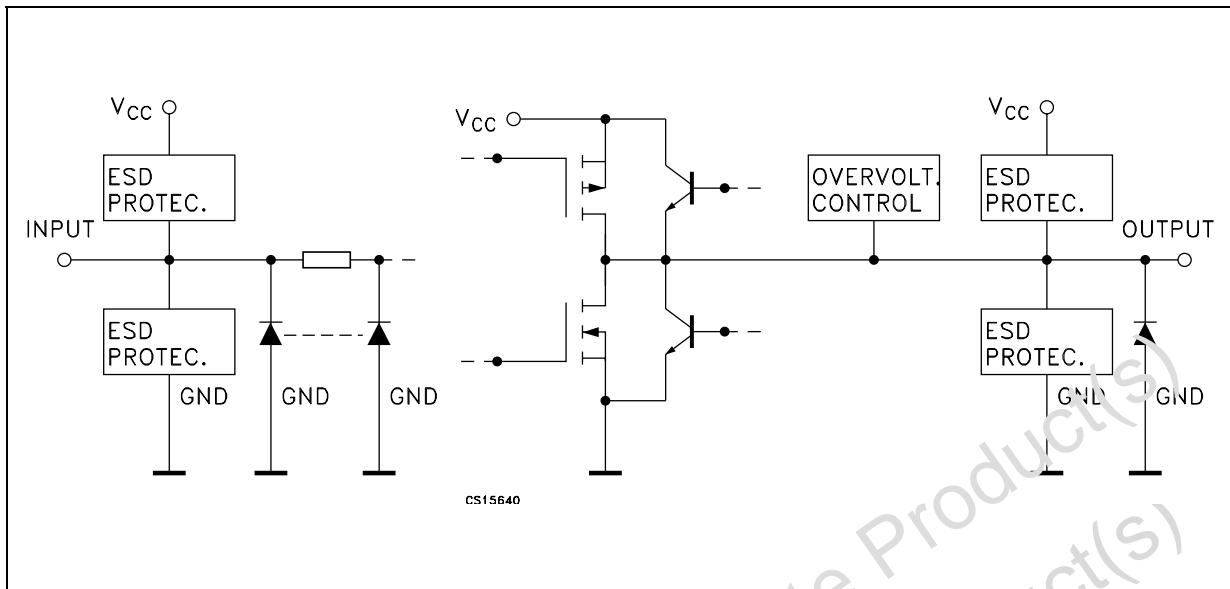
### ORDER CODES

PACKAGE	T & R
TSSOP48	74LVTH16244TTR
TFRGA4	74LVTH16244LBR

### LOGIC DIAGRAM

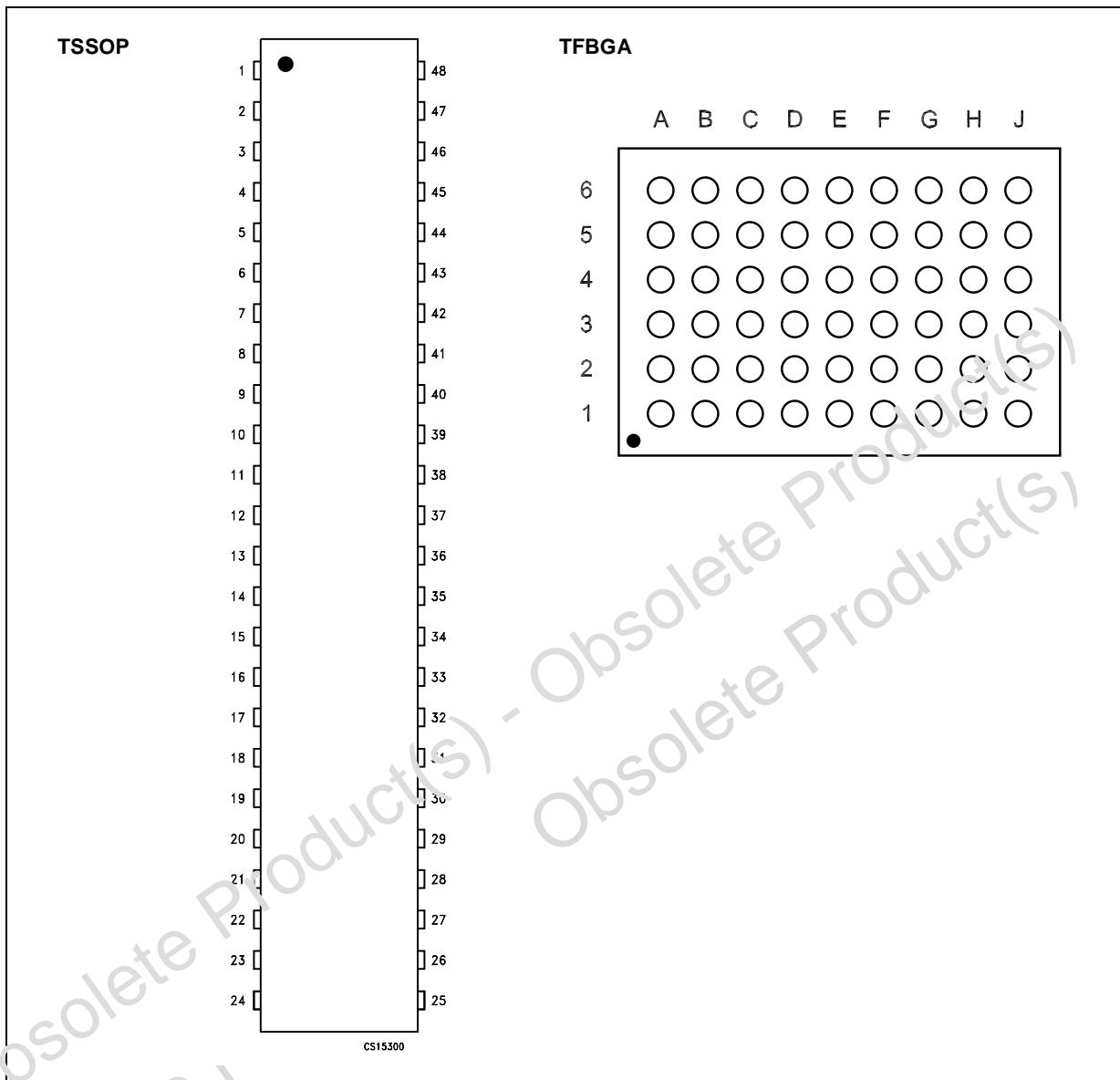


## INPUT AND OUTPUT EQUIVALENT CIRCUIT



## PIN DESCRIPTION

TFBGA PIN N°	TSSOP PIN N°	SYMBOL	NAME AND FUNCTION
A3, J3	1, 24	1G, 4G	Output Enable Inputs
A6, B5, B6, C5, C6, D5, D6, E5, E6, F5, F6, G5, G6, H5, H6, J6	47, 46, 14, 43, 41, 40, 38, 37, 36, 25, 33, 32, 30, 29, 27, 26	1A1-4, 2A1-4 3A1-4, 4A1-4	Data Inputs
A1, B2, B1, C2, C1, D2, D1, E2, E1, F2, F1, G2, G1, H2, H1, J1	2, 3, 5, 6, 8, 9, 11, 12, 13, 14, 16, 17, 19, 20, 22, 23	1Y1-4, 2Y1-4 3Y1-4, 4Y1-4	Data Outputs
J4, A4	25, 48	3G, 2G	Output Enable Inputs
D3, D4, E3, E4, F3, F4	4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
A2, A5, B3, B4, F3, F4, J2, J5	-	NC	No Connected
C4, G4, C3, G3	42, 31, 7, 18	V <sub>CC</sub>	Positive Supply Voltage

**PIN CONNECTION** (top view for TSSOP, top through view for BGA)**TRUTH TABLE**

INPUTS		OUTPUT
$\overline{nG}$	$xAn$	$xYn$
L	L	L
L	H	H
H	X	Z

Z = High Impedance; X = Don't care, n = 1..4, x = 1..4

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	-0.5 to +4.6	V
$V_I$	DC Input Voltage	-0.5 to +4.6	V
$V_O$	DC Output Voltage (Output disabled)	-0.5 to +4.6	V
$V_O$	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
$I_{IK}$	DC Input Diode Current	-50	mA
$I_{OK}$	DC Output Diode Current	-50	mA
$I_O$	DC Output Current low state	128	mA
$I_O$	DC Output Current high state	64	mA
$I_{CC}$	DC $V_{CC}$ or Ground Current	$\pm 100$	mA
$P_d$	Power Dissipation (*)	400	mW
$T_{stg}$	Storage Temperature	-65 to +150	°C
$T_L$	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

(\*) 500mW:  $\geq 65^{\circ}\text{C}$  derated to 300mW by 10mW/°C:  $65^{\circ}\text{C}$  to  $85^{\circ}\text{C}$

**RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	2.7 to 3.6	V
$V_I$	Input Voltage ( $A_n, nG$ )	0 to 3.6	V
$V_O$	Output Voltage	$V_{CC}$	V
$V_O$	Output Voltage (Output Disabled)	3.6	V
$T_{op}$	Operating Temperature	-40 to 85	°C
$dt/dV_{CC}$	Minimum Power-up ramp rate	200	μs/V
$dt/dv$	Input Rise and Fall Time (note 1)	0 to 20	ns/V

1)  $V_I$  from 0.8V to 2.0V at  $V_{CC} = 2.7$  to 3.6V

## DC SPECIFICATIONS

Symbol	Parameter	Test Condition		Value					Unit	
		$V_{CC}$ (V)		$T_A = 25^\circ C$			$-40 \text{ to } 85^\circ C$			
				Min.	Typ.	Max.	Min.	Max.		
$V_{IK}$	Input Voltage Clamp (An, nG)	2.7	$I_{IK} = -18\text{mA}$		-0.85			-1.2	V	
$V_{IH}$	High Level Input Voltage (An, nG)	2.7				2.0		2.0	V	
		3.3 (*)				2.0		2.0		
$V_{IL}$	Low Level Input Voltage (An, nG)	2.7		0.8			0.8		V	
		3.3 (*)		0.8			0.8			
$I_I$	Control Input Leakage Current	3.6	$V_I = GND \text{ or } V_{CC}$					$\pm 1$	$\mu A$	
	Data Input Leakage Current	3.6	$V_I = GND \text{ or } V_{CC}$ $nG = GND$					$\pm 1$	$\mu A$	
$I_{I(HOLD)}$	Data Input Hold Current	3.0	$V_I = 0.8V$		135		75		$\mu A$	
		3.0	$V_I = 2.0V$		-135		-75		$\mu A$	
		3.6	$V_I = 0 \text{ to } 3.6V$					$\pm 500$	$\mu A$	
$V_{OH}$	High Level Output Voltage	2.7	$I_O = -100 \mu A$			2.5			V	
		2.7	$I_O = -8 \text{ mA}$			2.4				
		3.0	$I_O = -32 \text{ mA}$			2.0				
$V_{OL}$	Low Level Output Voltage	2.7	$I_O = 100 \mu A$					0.2	V	
		2.7	$I_O = 24 \text{ mA}$					0.5		
		3.0	$I_O = 16 \text{ mA}$					0.4		
		3.0	$I_O = 32 \text{ mA}$					0.5		
		3.0	$I_O = 64 \text{ mA}$					0.55		
$I_{OZ}$	High Impedance Output Leakage Current	3.6	$V_O = 0.5V \text{ or } 3.0V$ $V_I = V_{IL} \text{ or } V_{IH}$ $nG = V_{CC}$					$\pm 5$	$\mu A$	
$I_{OZPU}$	High Impedance Output Leakage Current	0 to 1.5	$V_O = 0.5V \text{ or } 3.0V$ $V_I = GND \text{ or } V_{CC}$ $nG = GND \text{ or } V_{CC}$					$\pm 100$	$\mu A$	
$I_{OZPD}$	High Impedance Output Leakage Current	1.5 to 0	$V_O = 0.5V \text{ or } 3.0V$ $V_I = GND \text{ or } V_{CC}$ $nG = GND \text{ or } V_{CC}$					$\pm 100$	$\mu A$	
$I_{OFF}$	Power Off Leakage Current	0	$V_I = GND \text{ to } 3.6V$ $V_O = GND \text{ to } 3.6V$					$\pm 100$	$\mu A$	
$I_{CCA}$	Quiescent Supply Current	3.6	$V_O = \text{High}, I_O = 0$					0.19	mA	
			$V_O = \text{Low}, I_O = 0$					5.0		
			$nG = V_{CC}, I_O = 0$ $V_O = GND \text{ or } V_{CC}$					0.19		
$\Delta I_{CC}$	Maximum Quiescent Supply Current / Input (An or nG)	3.3 (*)	$V_I = V_{CC} - 0.6V$ An, nG = V <sub>CC</sub> or GND					0.2	mA	

(\*) Power Supply Range  $V_{CC} = 3.3 \pm 0.3V$

## AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Condition	Value					Unit	
			V <sub>CC</sub> = 2.7V		V <sub>CC</sub> = 3.3 ± 0.3V				
			Min.	Max.	Min.	Typ.	Max.		
t <sub>PLH</sub>	Propagation Delay Time An to Y <sub>n</sub>	T <sub>A</sub> = - 40 to 85 °C		3.7	1.2	2.5	3.2	ns	
t <sub>PHL</sub>	Propagation Delay Time An to Y <sub>n</sub>			3.7	1.2	2.5	3.2	ns	
t <sub>PZL</sub>	Output Enable Time nG to Y <sub>n</sub>			5.0	1.2	2.7	4.0	ns	
t <sub>PZH</sub>	Output Enable Time nG to Y <sub>n</sub>			5.0	1.2	2.7	4.0	ns	
t <sub>PLZ</sub>	Output Disable Time nG to Y <sub>n</sub>			4.4	2.0	3.7	4.2	ns	
t <sub>PHZ</sub>	Output Disable Time nG to Y <sub>n</sub>			5.0	2.2	4.4	5.1	ns	
t <sub>OSLH</sub> t <sub>OSSH</sub>	Output To Output Skew Time (note1, 2)						0.5	ns	

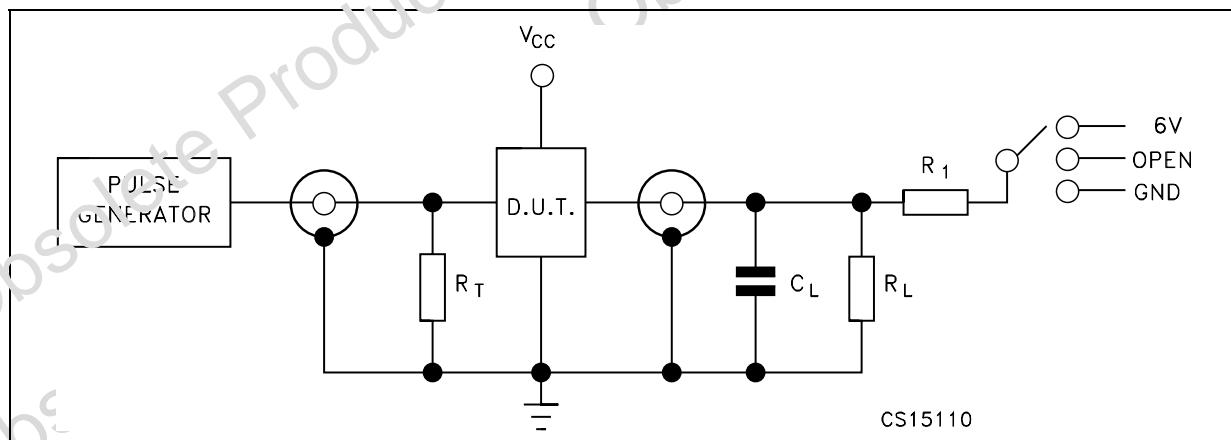
1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ( $t_{OSLH} = |t_{PLHm} - t_{PLHn}|$ ,  $t_{OSSH} = |t_{PHLm} - t_{PHLn}|$ )

2) Parameter guaranteed by design

## CAPACITANCE CHARACTERISTICS

Symbol	Parameter	Test Condition		Value					Unit	
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C		-40 to 85 °C				
				Min.	Typ.	Max.	Min.	Max.		
C <sub>I</sub>	Control Input Capacitance	open			6				pF	
C <sub>O</sub>	Output Capacitance	3.3			15				pF	

## TEST CIRCUIT



TEST	SWITCH
t <sub>PLH</sub> , t <sub>PHL</sub>	Open
t <sub>PZL</sub> , t <sub>PLZ</sub> (V <sub>CC</sub> = 3.0 to 3.6V)	6V
t <sub>PZL</sub> , t <sub>PLZ</sub> (V <sub>CC</sub> = 2.7V)	6V
t <sub>PZH</sub> , t <sub>PHZ</sub>	GND

C<sub>L</sub> = 50pF or equivalent (includes jig and probe capacitance)

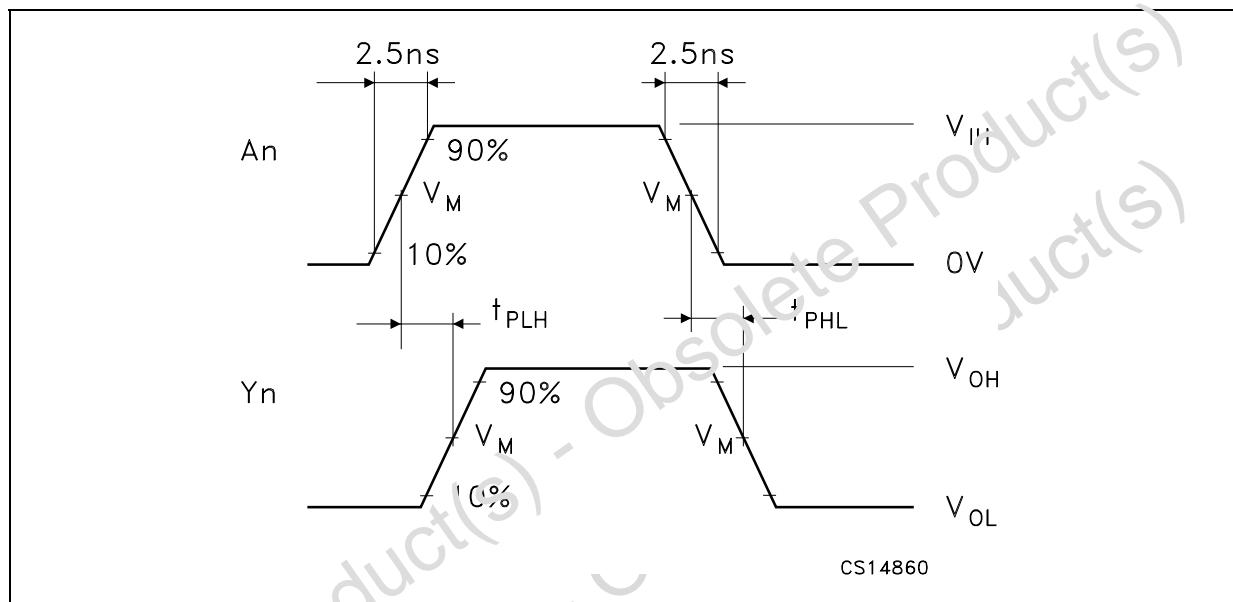
R<sub>L</sub> = R<sub>1</sub> = 500Ω or equivalent

R<sub>T</sub> = Z<sub>OUT</sub> of pulse generator (typically 50Ω)

## WAVEFORM SYMBOL VALUE

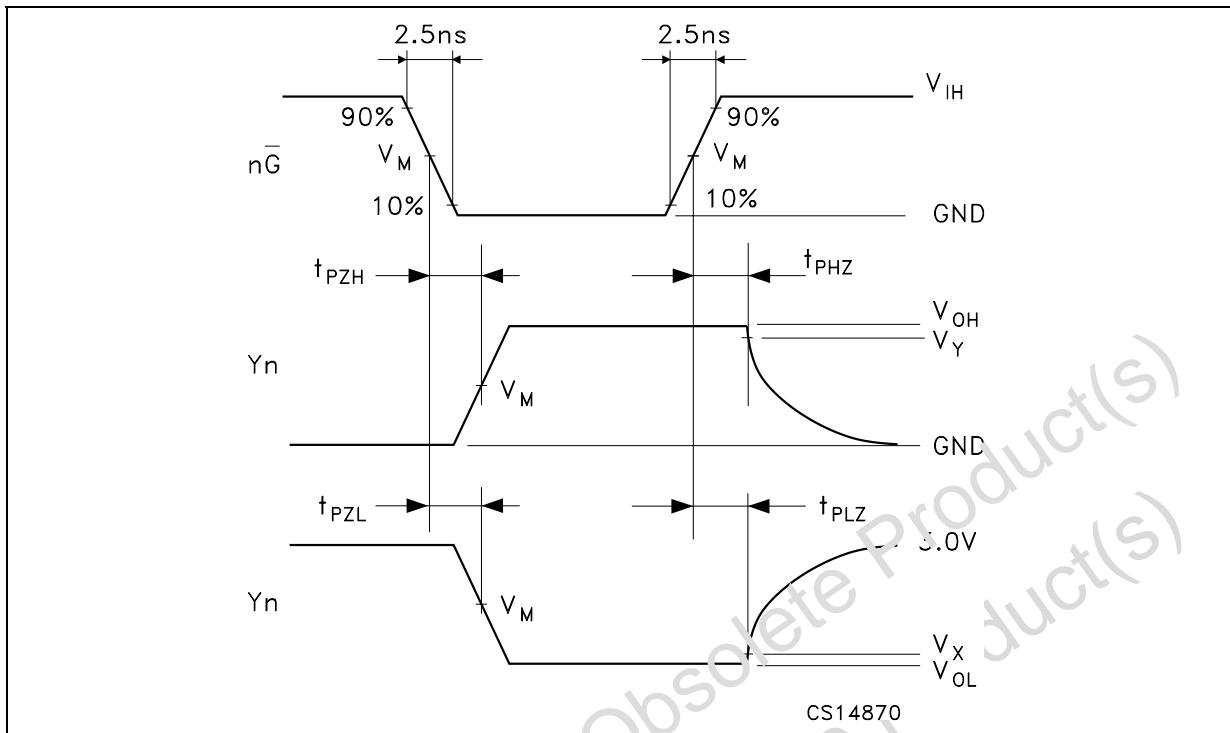
Symbol	$V_{CC}$	
	3.0 to 3.6V	2.7V
$V_{IH}$	2.7V	$V_{CC}$
$V_M$	1.5V	1.5V
$V_X$	$V_{OL} + 0.3V$	$V_{OL} + 0.15V$
$V_Y$	$V_{OH} - 0.3V$	$V_{OH} - 0.15V$

## WAVEFORM 1: PROPAGATION DELAY (f=1MHz; 50% duty cycle)



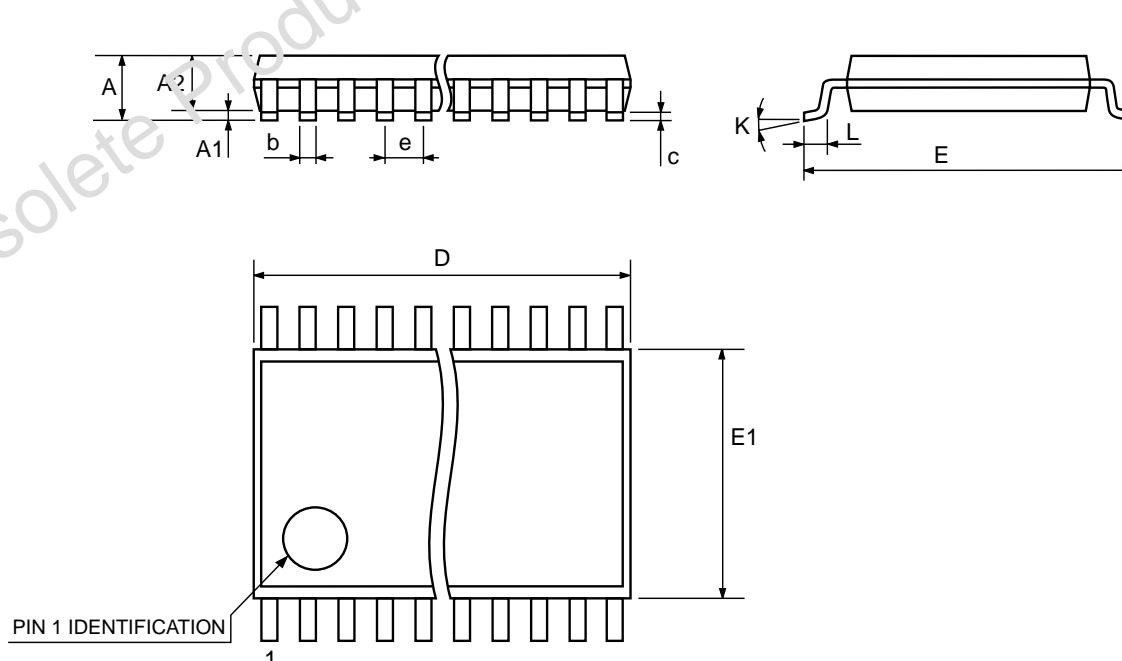
CS14860

**WAVEFORM 2: OUTPUT ENABLE AND DISABLE TIME (f=1MHz; 50% duty cycle)**



## TSSOP48 MECHANICAL DATA

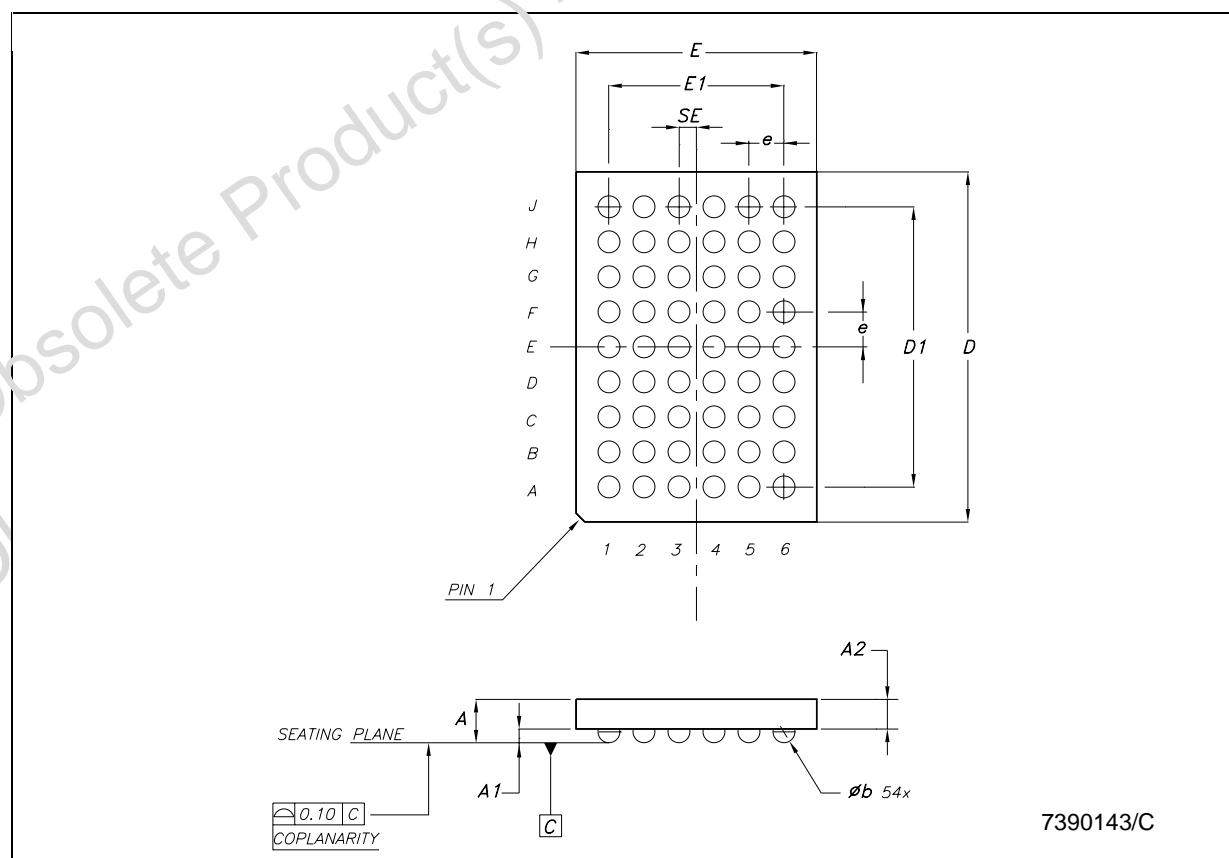
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2		0.9			0.035	
b	0.17		0.27	0.0067		0.011
c	0.09		0.20	0.0035		0.0079
D	12.4		12.6	0.488		0.496
E		8.1 BSC			0.318 BSC	
E1	6.0		6.2	0.233		0.244
e		0.5 BSC			0.0197 BSC	
K	0°		8°	0°		8°
L	0.50		0.75	0.020		0.030



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## TFBGA54 MECHANICAL DATA

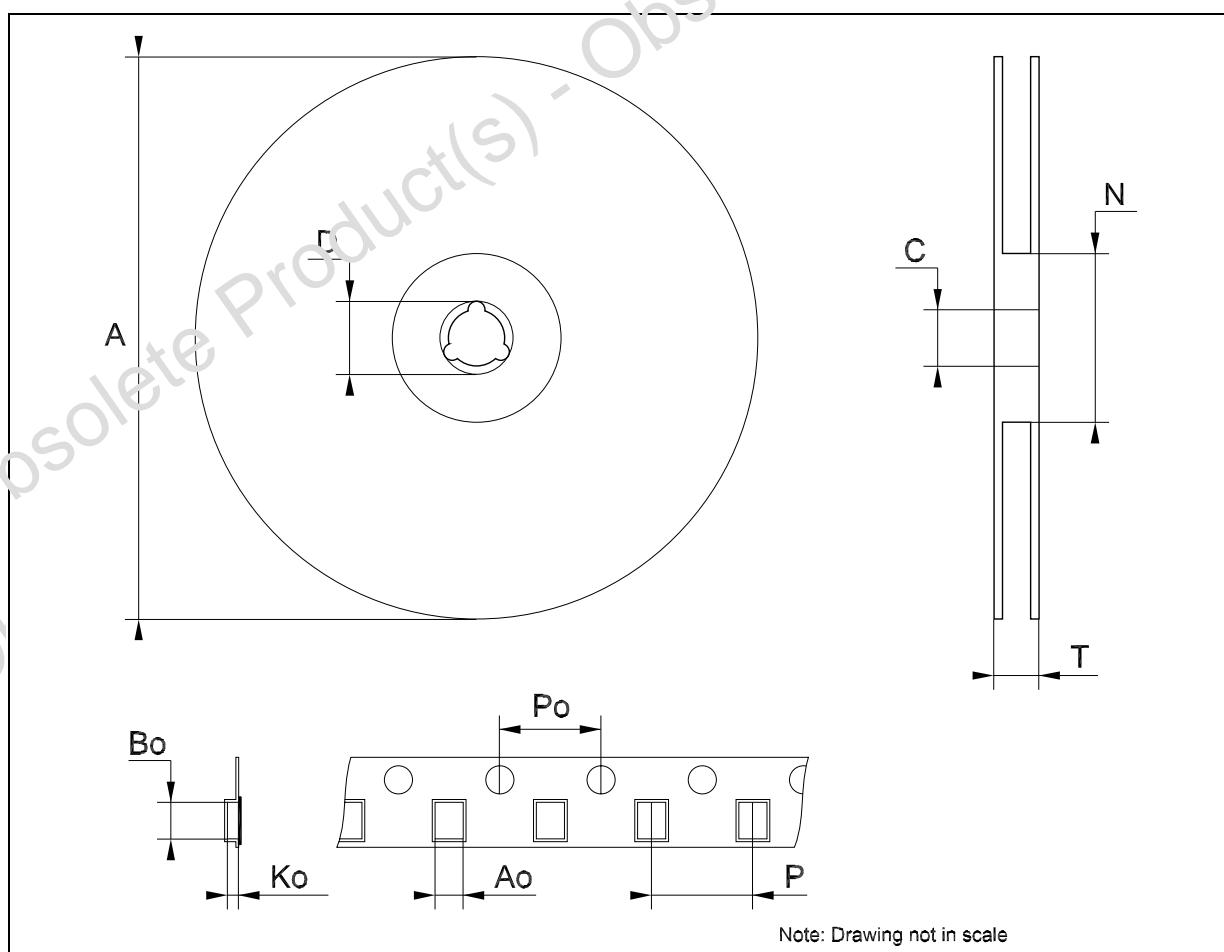
DIM.	mm.			mils		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			47.2
A1	0.25			9.8		
A2	0.78		0.86	30.7		33.8
B	0.35	0.4	0.45	13.7	15.7	17.7
D	7.9		8.1	311.0		318.9
D1		6.4			252.0	
E	5.4	5.5	5.6	212.6	216.5	220.5
E1		4			157.5	
e		0.8			31.5	
SE		0.4			15.7	



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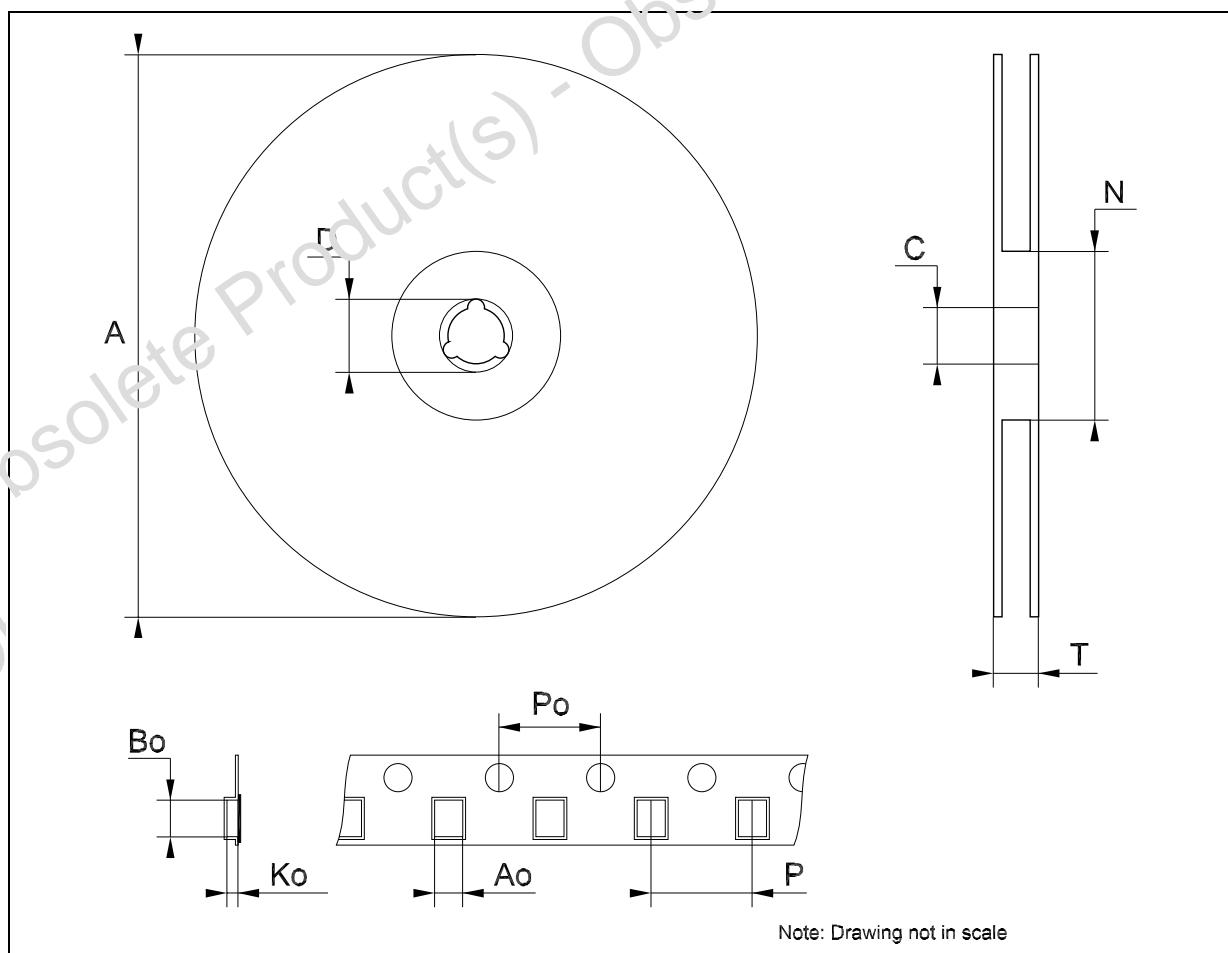
<b>Tape &amp; Reel TSSOP48 MECHANICAL DATA</b>
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DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			30.4			1.197
Ao	8.7		8.9	0.343		0.350
Bo	13.1		13.3	0.516		0.524
Ko	1.5		1.7	0.059		0.067
Po	3.9		4.1	0.153		0.161
P	11.9		12.1	0.468		0.476



## Tape &amp; Reel TFBGA54 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao		6.1			0.240	
Bo		8.6			0.339	
Ko		1.8			0.071	
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



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